



Vincotech

**B0-SP07NIB300S5-LT82F58T
B0-SP07NIC300S5-LT92F58T**

datasheet

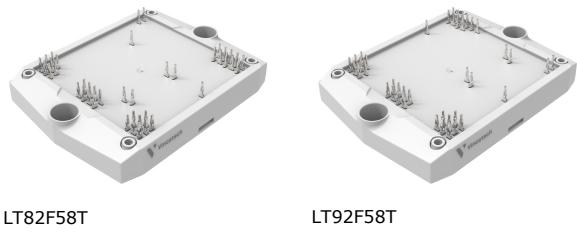
flowNPC S3 split

650 V / 300 A

Features

- Split NPC topology
- Optimized for 1200 Vdc applications
- Split topology for improved thermal performance
- Low inductive mid-power package

flow S3 12 mm housing



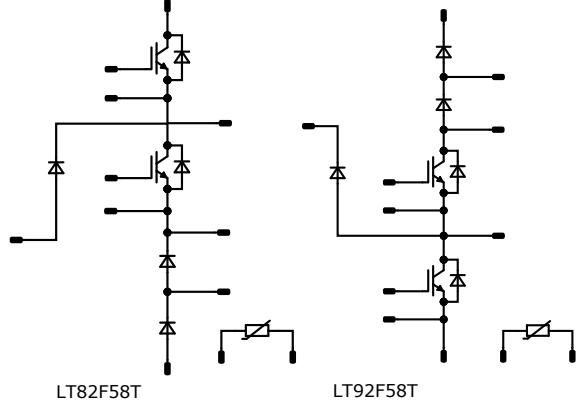
Target applications

- Solar Inverters

Types

- B0-SP07NIB300S5-LT82F58T
- B0-SP07NIC300S5-LT92F58T

Schematic





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**B0-SP07NIB300S5-LT82F58T
B0-SP07NIC300S5-LT92F58T**

datasheet

Maximum Ratings

 $T_j = 25 \text{ }^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Buck Switch				
Collector-emitter voltage	V_{CES}		650	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	217	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	900	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	302	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Buck Diode

Peak repetitive reverse voltage	V_{RRM}		650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	231	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	600	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	301	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Buck Sw. Protection Diode

Peak repetitive reverse voltage	V_{RRM}		650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	38	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	60	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	64	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$



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Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	217	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	900	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	302	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Boost Diode

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Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	231	A
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Boost Sw. Inv. Diode

Peak repetitive reverse voltage	V_{RRM}		650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	231	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	600	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	301	W
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Forward current (DC current)	I_F	$T_j = T_{jmax}$	38	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	60	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	64	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	$^\circ\text{C}$

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage*	$t_p = 2 \text{ s}$	6000	V
Isolation voltage	V_{isol}	AC Voltage	$t_p = 1 \text{ min}$	2500	V
Creepage distance				8,83	mm
Clearance				7,46	mm
Comparative Tracking Index	CTI			≥ 600	

*100 % tested in production



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Buck Sw. Protection Diode

Static

Forward voltage	V_F				30	25 125	1,23	1,7 1,59	1,87 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 650$ V			25			0,36	μ A	

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 4,4$ W/mK (PTM)						1,49		K/W
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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Boost Sw. Inv. Diode

Static

Forward voltage	V_F				300	25 125 150		1,53 1,48 1,46	1,92 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 650$ V				25			15,2	µA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{\text{paste}} = 4,4 \text{ W/mK}$ (PTM)						0,32		K/W
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Boost Sw. Protection Diode

Static

Forward voltage	V_F				30	25 125	1,23	1,7 1,59	1,87 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 650$ V				25			0,36	µA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{\text{paste}} = 4,4 \text{ W/mK}$ (PTM)						1,49		K/W
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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Thermistor

Static

Rated resistance	R					25		22		kΩ
Deviation of R_{100}	$A_{R/R}$	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	P							5		mW
Power dissipation constant	d					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %						3962		K
B-value	$B_{(25/100)}$	Tol. ±1 %						4000		K
Vincotech Thermistor Reference									I	

⁽¹⁾ Value at chip level⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.



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Buck Switch Characteristics

figure 1. IGBT

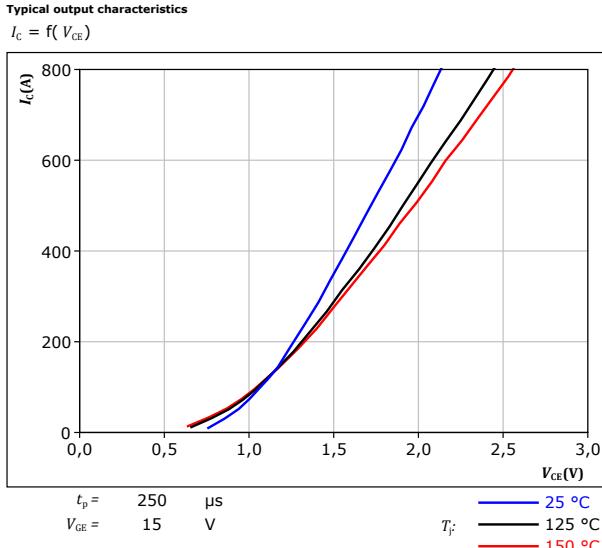


figure 2. IGBT

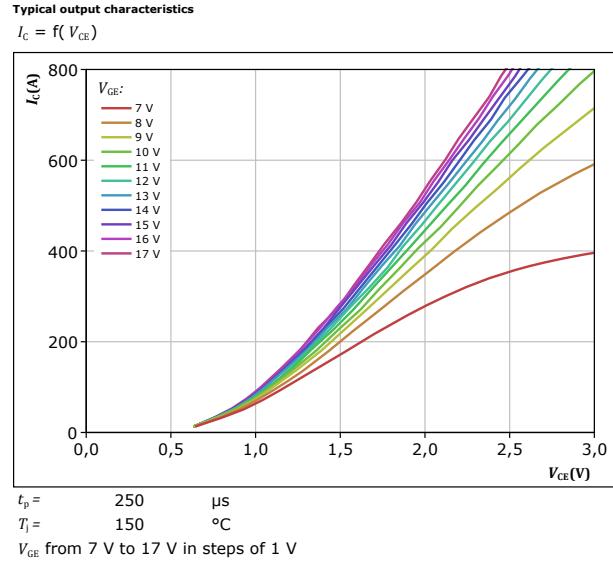


figure 3. IGBT

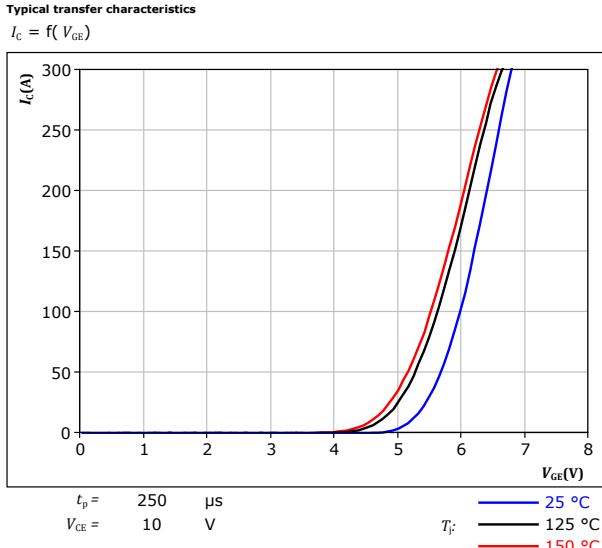
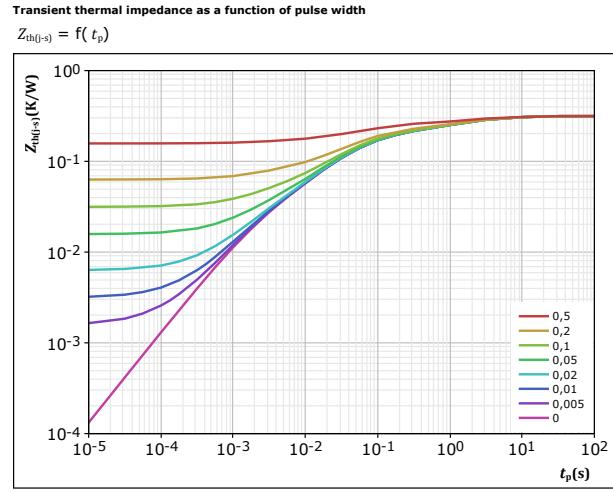


figure 4. IGBT



R (K/W)	τ (s)
4,24E-02	6,04E+00
8,01E-02	9,42E-01
1,23E-01	7,13E-02
5,43E-02	1,58E-02
1,49E-02	1,87E-03

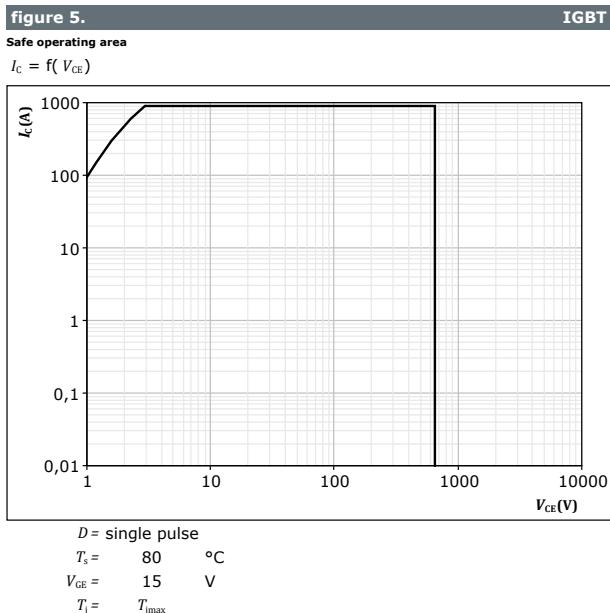


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Buck Switch Characteristics



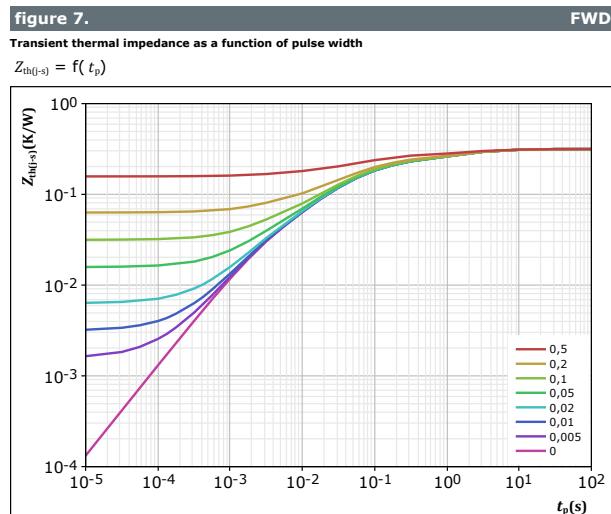
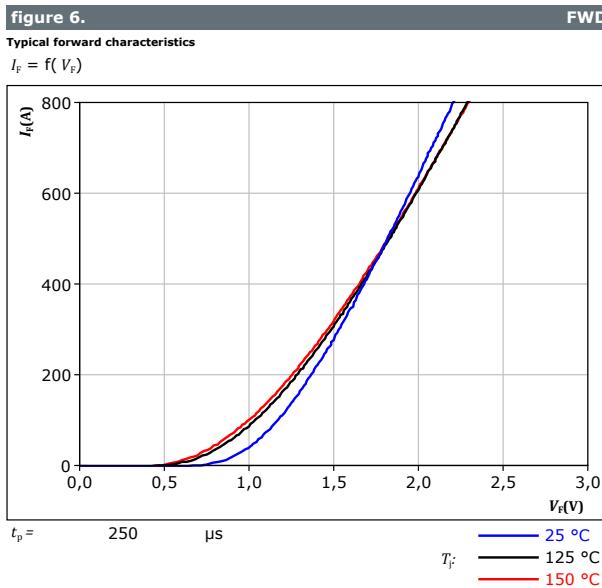


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Buck Diode Characteristics





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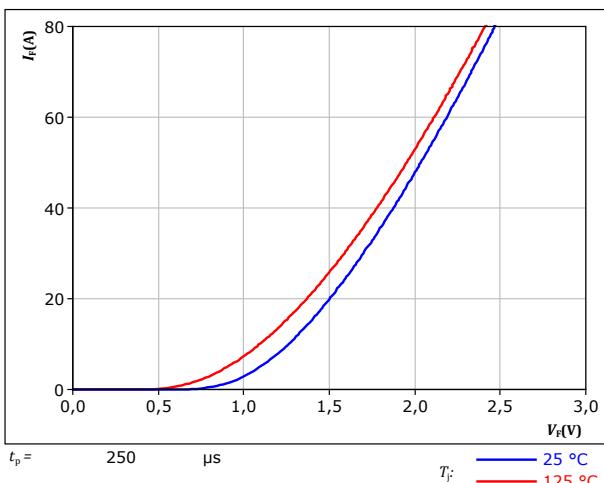
Buck Sw. Protection Diode Characteristics

figure 8.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD



$$t_p = 250 \mu\text{s}$$

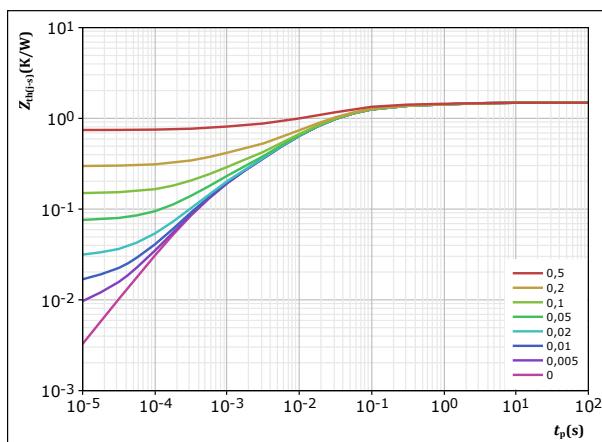
T_F : — 25 °C — 125 °C

figure 9.

Transient thermal impedance as a function of pulse width

$$Z_{th(t-s)} = f(t_p)$$

FWD



$$D = \frac{t_p}{T} \quad R_{th(t-s)} = \frac{t_p}{1,487} \text{ K/W}$$

FWD thermal model values

R (K/W)	τ (s)
1,05E-01	1,88E+00
2,50E-01	1,34E-01
6,86E-01	2,59E-02
3,22E-01	4,94E-03
1,24E-01	5,27E-04

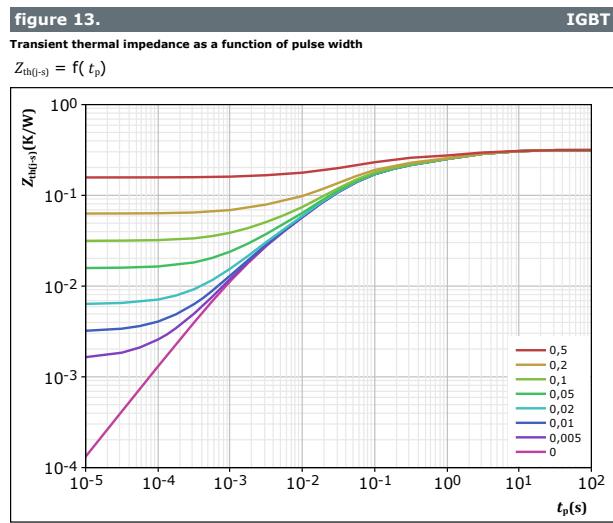
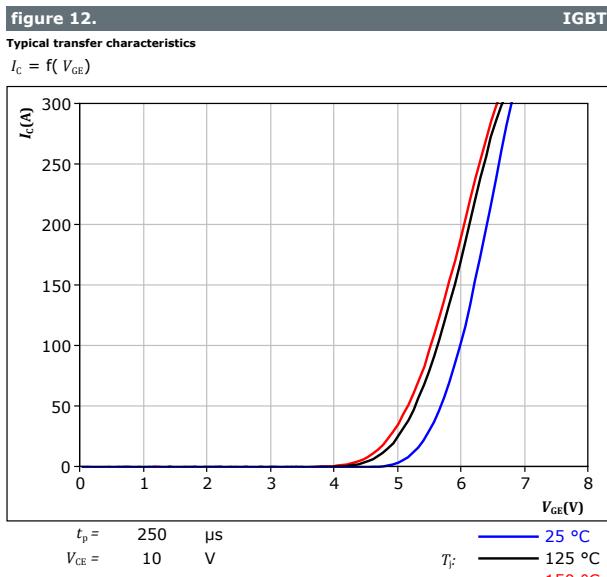
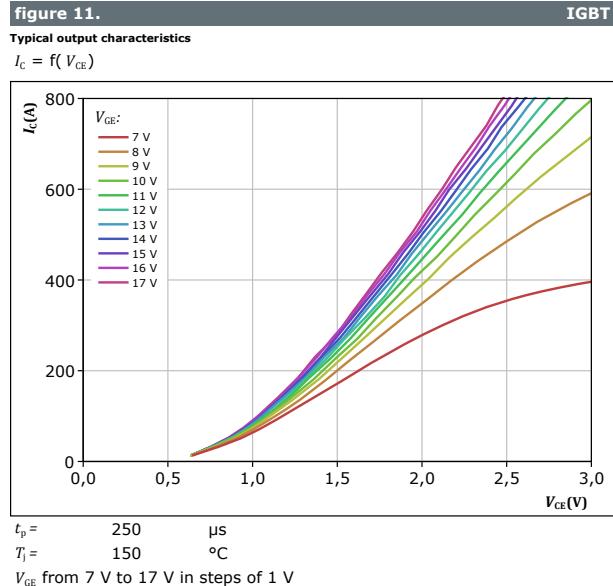
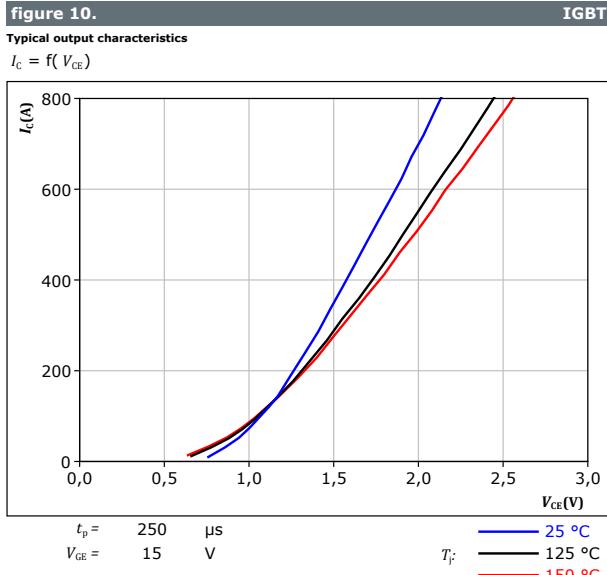


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datasheet

Boost Switch Characteristics



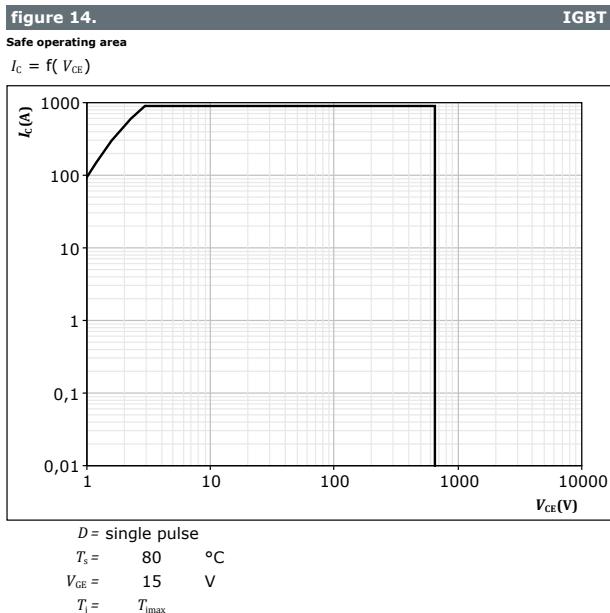


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datasheet

Boost Switch Characteristics





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datasheet

Boost Diode Characteristics

figure 15.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD

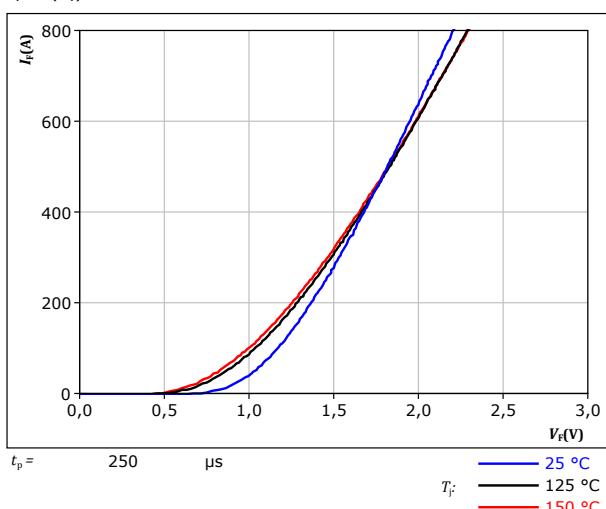
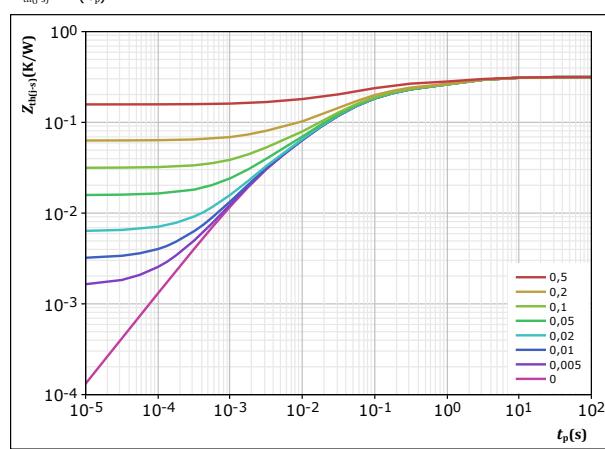


figure 16.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$D = t_p / T$	$R_{th(j-s)}$ K/W
FWD thermal model values	
R (K/W)	τ (s)
2,42E-02	6,44E+00
7,11E-02	1,30E+00
1,03E-01	1,08E-01
9,25E-02	2,52E-02
2,42E-02	2,86E-03



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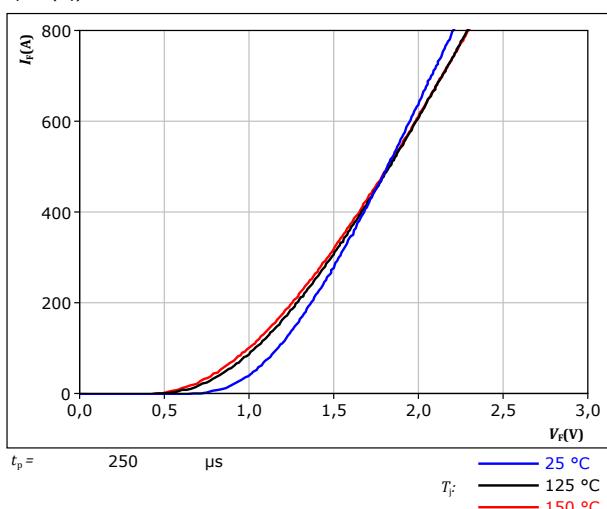
Boost Sw. Inv. Diode Characteristics

figure 17.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD



$$t_p = 250 \mu\text{s}$$

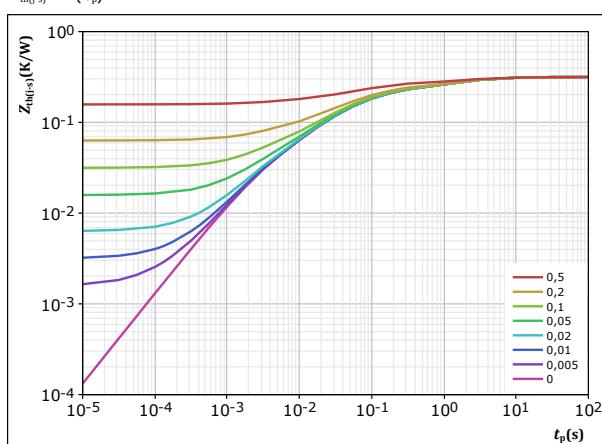
T_F :
— 25 °C
— 125 °C
— 150 °C

figure 18.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p / T}{R_{th(j-s)}} = 0,315 \text{ K/W}$$

FWD thermal model values

$R(K/W)$	$\tau(s)$
2,42E-02	6,44E+00
7,11E-02	1,30E+00
1,03E-01	1,08E-01
9,25E-02	2,52E-02
2,42E-02	2,86E-03



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Boost Sw. Protection Diode Characteristics

figure 19.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD

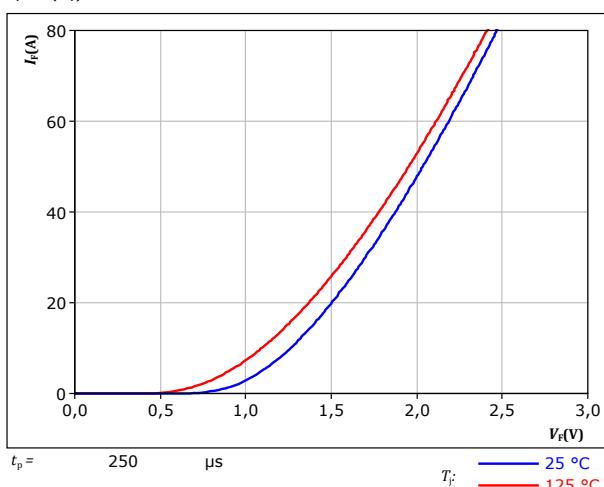
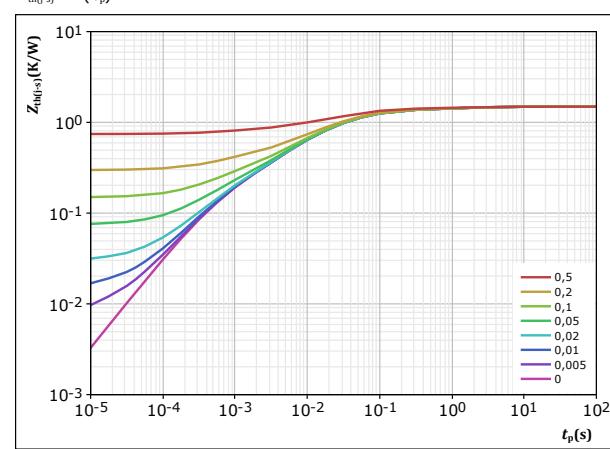


figure 20.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p / T}{1,487} \quad K/W$$

FWD thermal model values

R (K/W)	τ (s)
1,05E-01	1,88E+00
2,50E-01	1,34E-01
6,86E-01	2,59E-02
3,22E-01	4,94E-03
1,24E-01	5,27E-04



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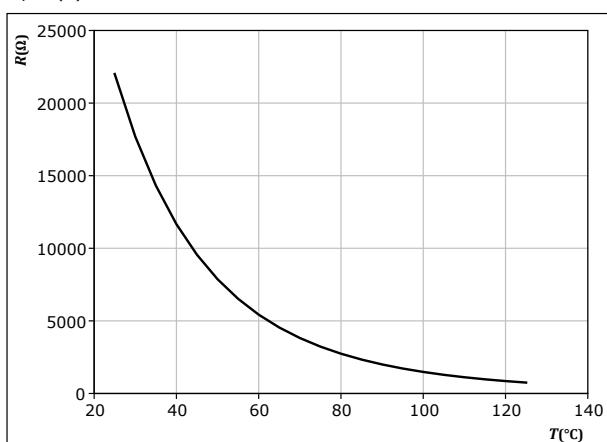
Thermistor Characteristics

figure 21.

Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$



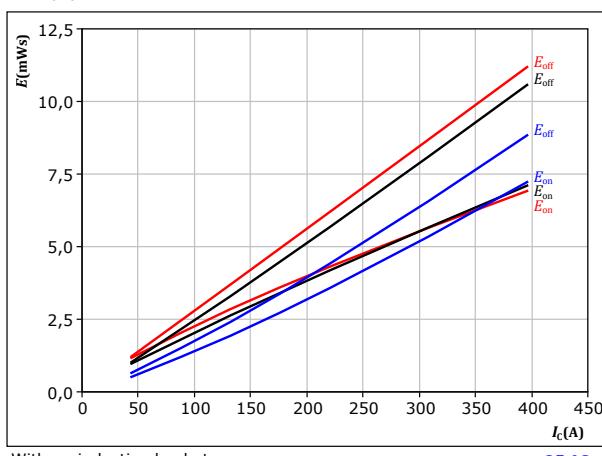


Buck Switching Characteristics

figure 22.

Typical switching energy losses as a function of collector current

IGBT



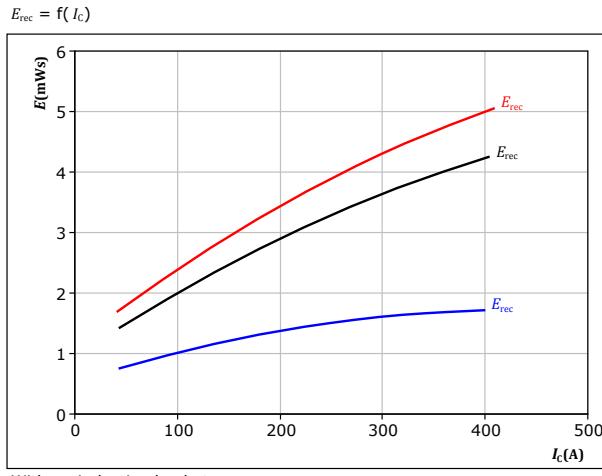
With an inductive load at

$V_{CE} = 350$ V T_f : $25^\circ C$
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8 \Omega$
 $R_{goff} = 8 \Omega$

figure 24.

Typical reverse recovered energy loss as a function of collector current

FWD



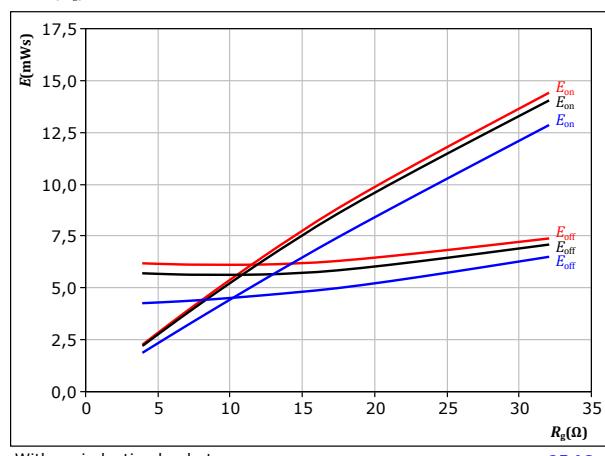
With an inductive load at

$V_{CE} = 350$ V T_f : $25^\circ C$
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8 \Omega$

figure 23.

Typical switching energy losses as a function of gate resistor

IGBT



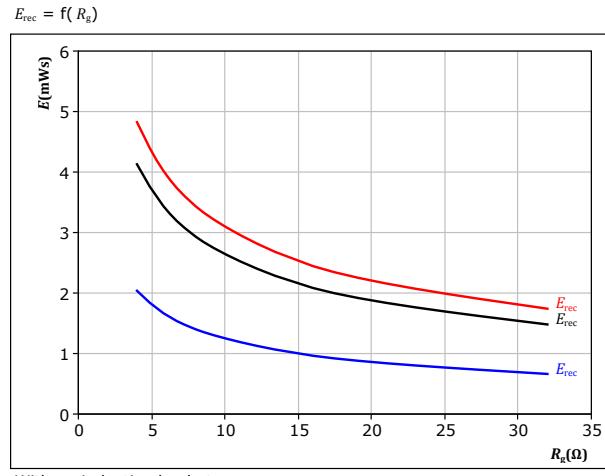
With an inductive load at

$V_{CE} = 350$ V T_f : $25^\circ C$
 $V_{GE} = \pm 15$ V
 $I_C = 220$ A
 $150^\circ C$

figure 25.

Typical reverse recovered energy loss as a function of gate resistor

FWD



With an inductive load at

$V_{CE} = 350$ V T_f : $25^\circ C$
 $V_{GE} = \pm 15$ V
 $I_C = 220$ A
 $150^\circ C$



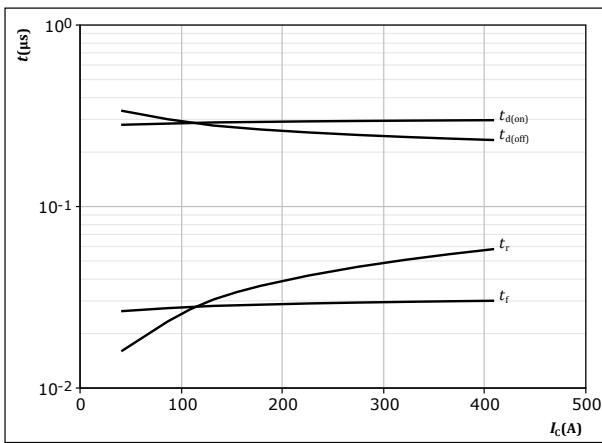
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datasheet

Buck Switching Characteristics

figure 26.

Typical switching times as a function of collector current
 $t = f(I_C)$



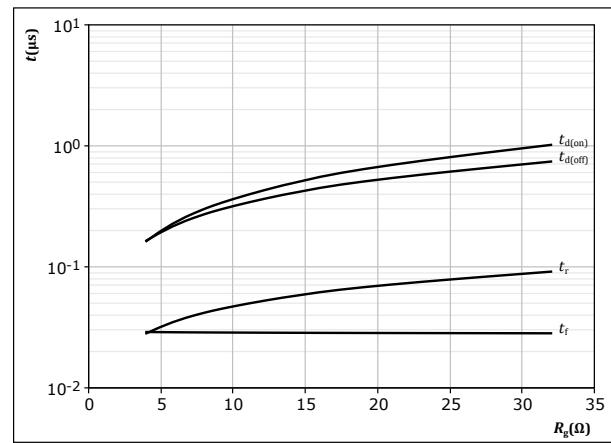
With an inductive load at

$T_J = 150 \text{ } ^\circ\text{C}$
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 8 \Omega$
 $R_{goff} = 8 \Omega$

IGBT

figure 27.

Typical switching times as a function of gate resistor
 $t = f(R_g)$



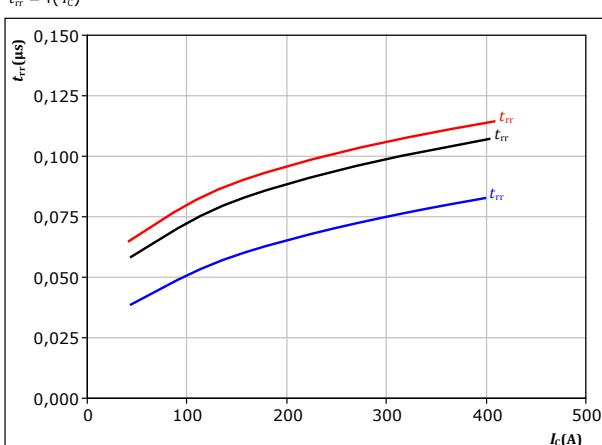
With an inductive load at

$T_J = 150 \text{ } ^\circ\text{C}$
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 220 \text{ A}$

IGBT

figure 28.

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$



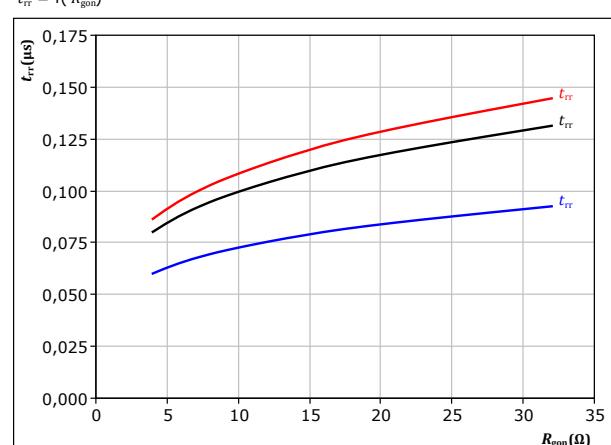
With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 8 \Omega$

FWD

figure 29.

Typical reverse recovery time as a function of IGBT turn on gate resistor
 $t_{rr} = f(R_{gon})$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 220 \text{ A}$

FWD



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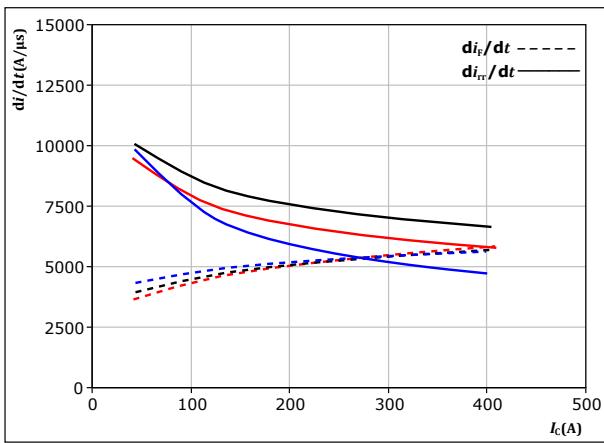
datasheet

Buck Switching Characteristics

figure 34.

FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$



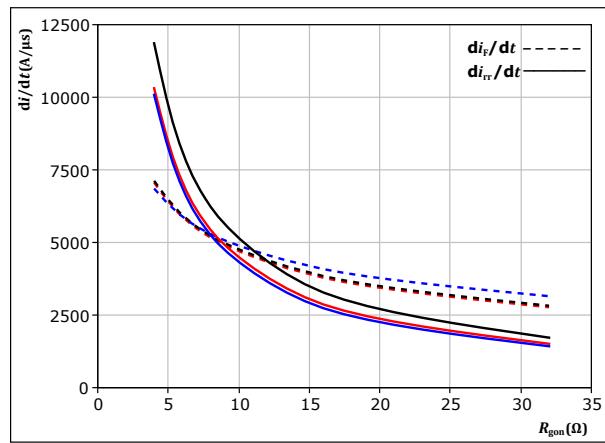
With an inductive load at

$V_{CE} = 350$ V $T_j = 25^\circ\text{C}$
 $V_{GE} = \pm 15$ V $T_j = 125^\circ\text{C}$
 $R_{gon} = 8$ Ω $T_j = 150^\circ\text{C}$

figure 35.

FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{gon})$



With an inductive load at

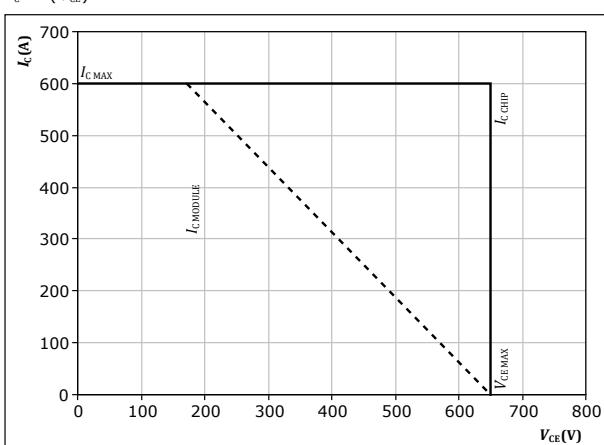
$V_{CE} = 350$ V $T_j = 25^\circ\text{C}$
 $V_{GE} = \pm 15$ V $T_j = 125^\circ\text{C}$
 $I_c = 220$ A $T_j = 150^\circ\text{C}$

figure 36.

IGBT

Reverse bias safe operating area

$$I_c = f(V_{CE})$$



At $T_j = 150^\circ\text{C}$
 $R_{gon} = 8$ Ω
 $R_{goff} = 8$ Ω



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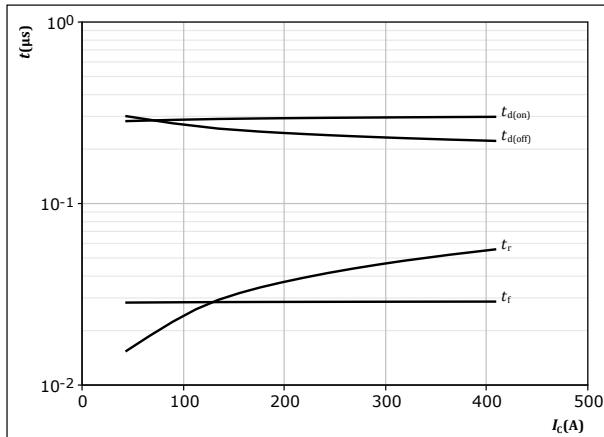
**BO-SP07NIB300S5-LT82F58T
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Boost Switching Characteristics

figure 41.

Typical switching times as a function of collector current
 $t = f(I_c)$



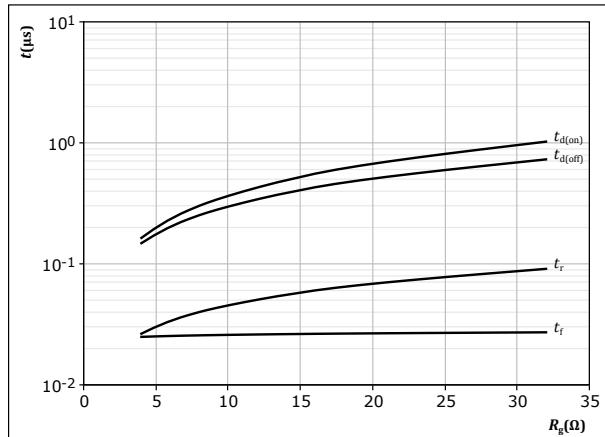
With an inductive load at

$T_j = 150 \text{ } ^\circ\text{C}$
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 8 \Omega$
 $R_{goff} = 8 \Omega$

IGBT

figure 42.

Typical switching times as a function of gate resistor
 $t = f(R_g)$



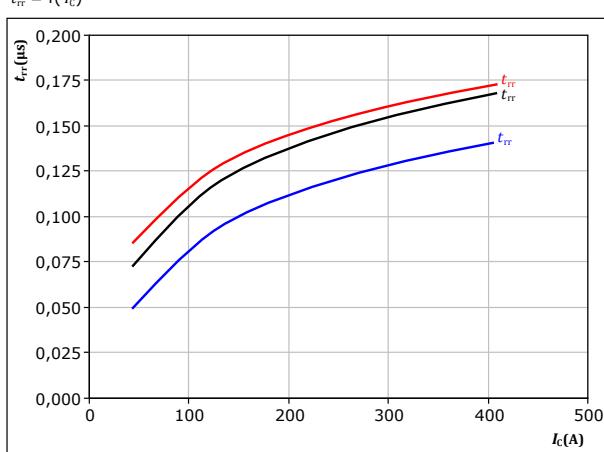
With an inductive load at

$T_j = 150 \text{ } ^\circ\text{C}$
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 220 \text{ A}$

IGBT

figure 43.

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_c)$



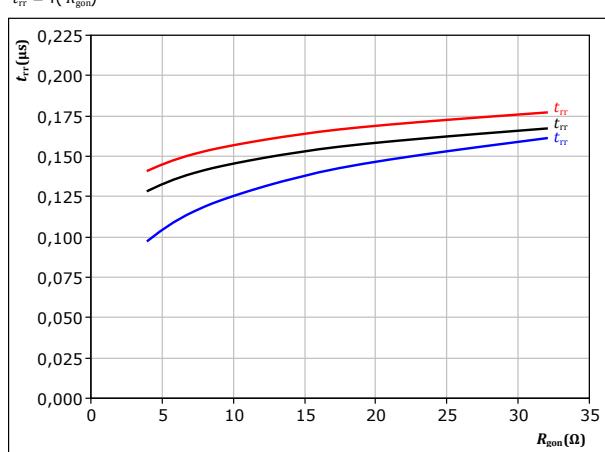
With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 8 \Omega$

FWD

figure 44.

Typical reverse recovery time as a function of IGBT turn on gate resistor
 $t_{rr} = f(R_{gon})$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 220 \text{ A}$

FWD



Boost Switching Characteristics

figure 45.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$

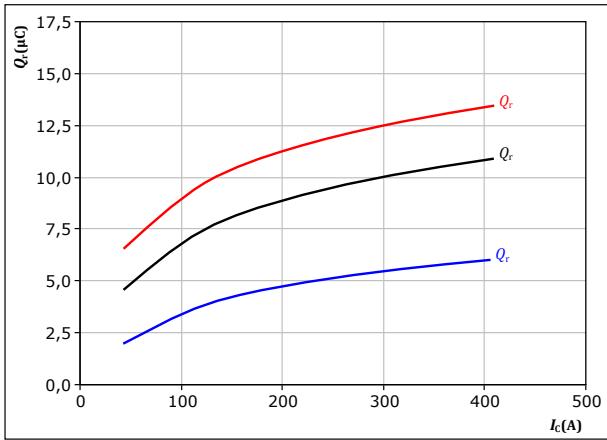


figure 47.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$

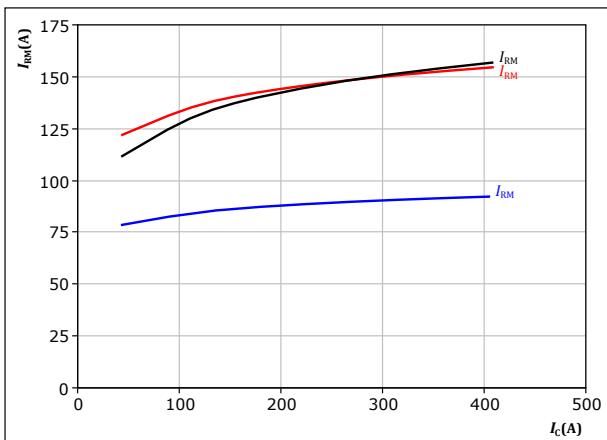


figure 46.

FWD

Typical recovered charge as a function of turn on gate resistor

$$Q_r = f(R_{gon})$$

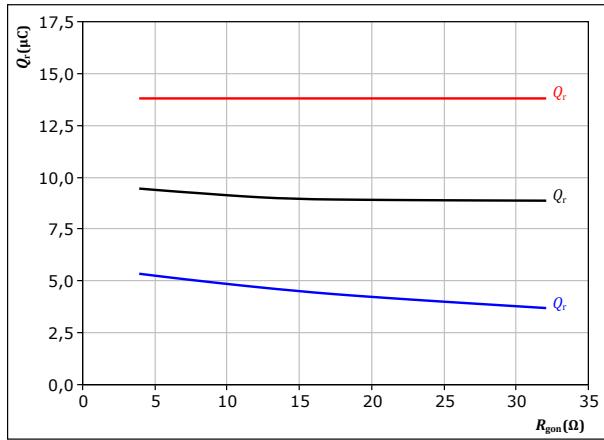
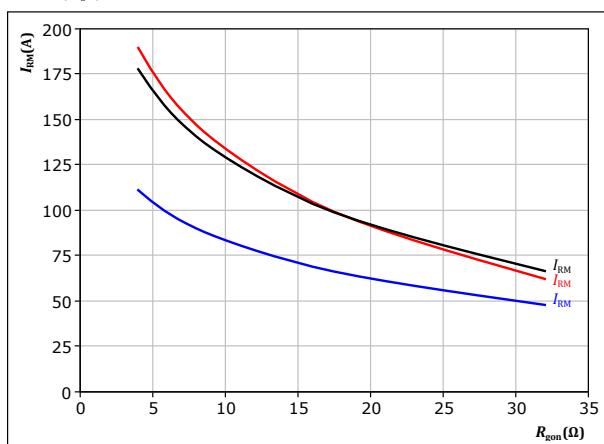


figure 48.

FWD

Typical peak reverse recovery current as a function of turn on gate resistor

$$I_{RM} = f(R_{gon})$$





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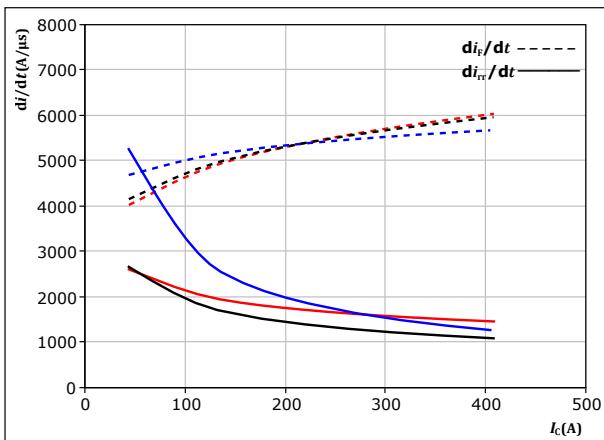
datasheet

Boost Switching Characteristics

figure 49.

FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$



With an inductive load at

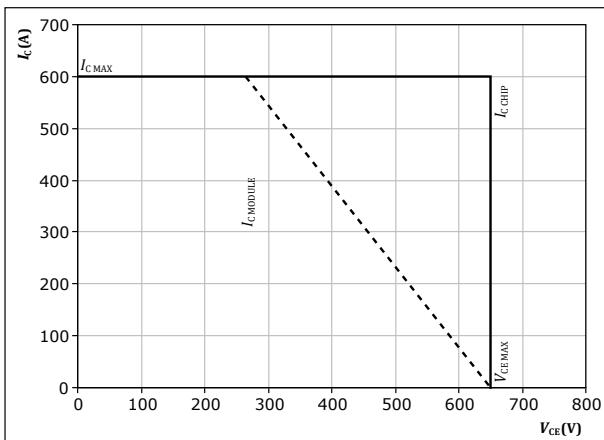
$V_{CE} = 350$ V $T_j = 25^\circ\text{C}$
 $V_{GE} = \pm 15$ V $T_j = 125^\circ\text{C}$
 $R_{gon} = 8$ Ω $T_j = 150^\circ\text{C}$

figure 51.

IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$

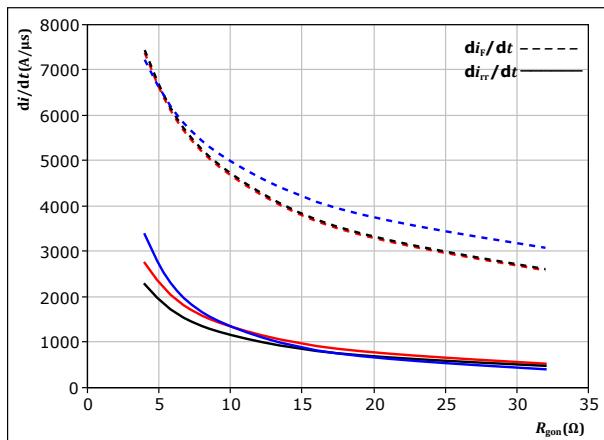


At $T_j = 150^\circ\text{C}$
 $R_{gon} = 8$ Ω
 $R_{goff} = 8$ Ω

figure 50.

FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{gon})$



With an inductive load at

$V_{CE} = 350$ V $T_j = 25^\circ\text{C}$
 $V_{GE} = \pm 15$ V $T_j = 125^\circ\text{C}$
 $I_c = 220$ A $T_j = 150^\circ\text{C}$



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Switching Definitions

figure 52. IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

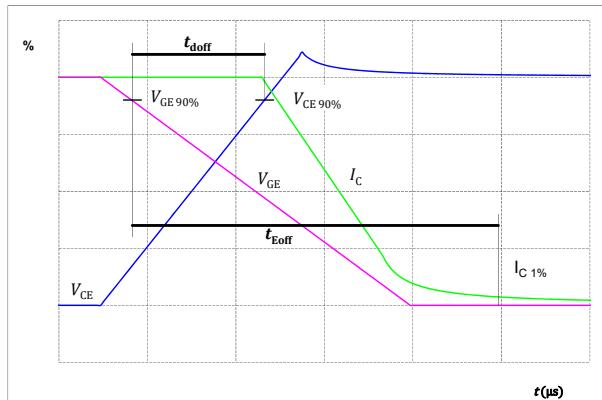


figure 53. IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

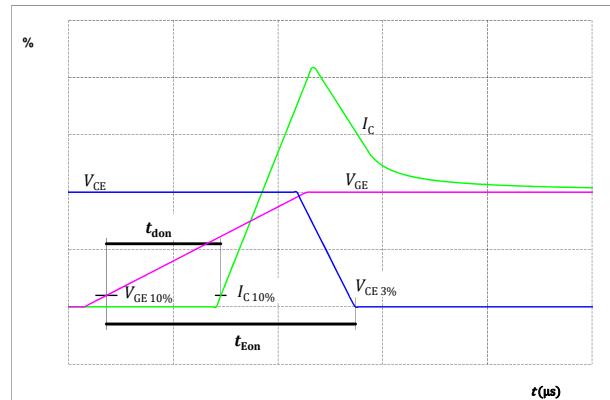


figure 54. IGBT

Turn-off Switching Waveforms & definition of t_f

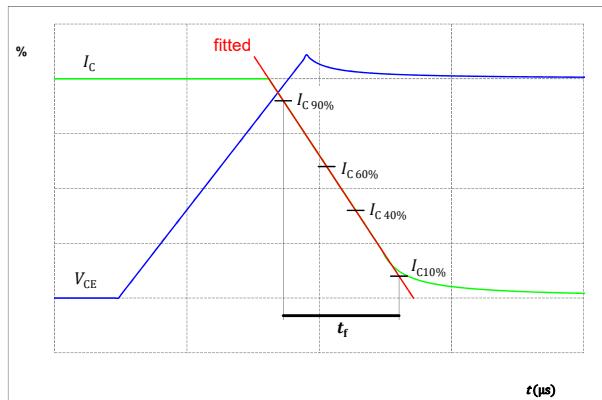
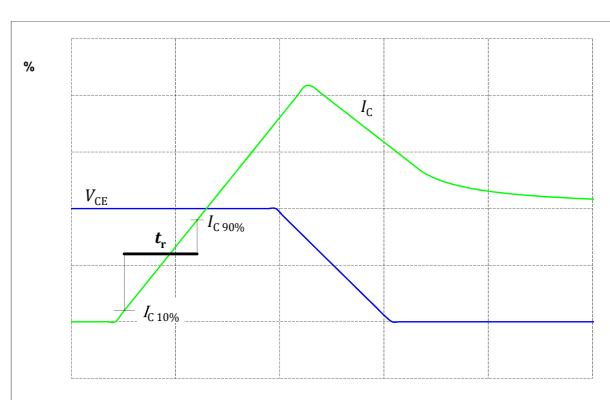


figure 55. IGBT

Turn-on Switching Waveforms & definition of t_r





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Switching Definitions

figure 56.

Turn-off Switching Waveforms & definition of t_{tr}

FWD

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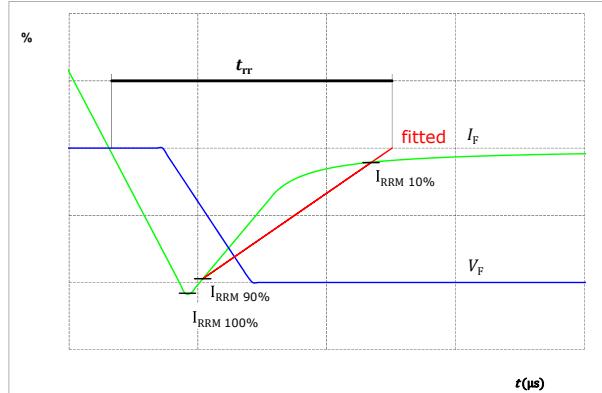
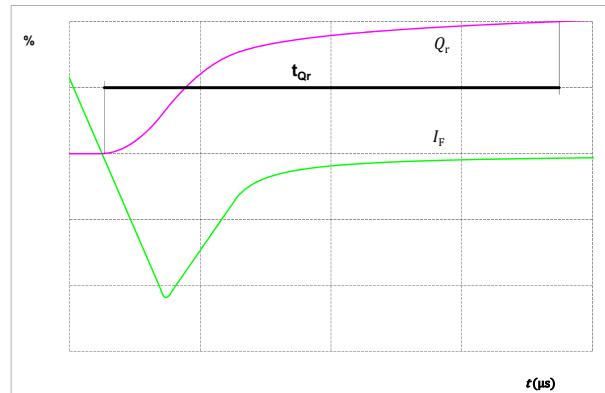


figure 57.

Turn-on Switching Waveforms & definition of t_{qr} (t_{qr} = integrating time for Q_r)

FWD

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Ordering Code

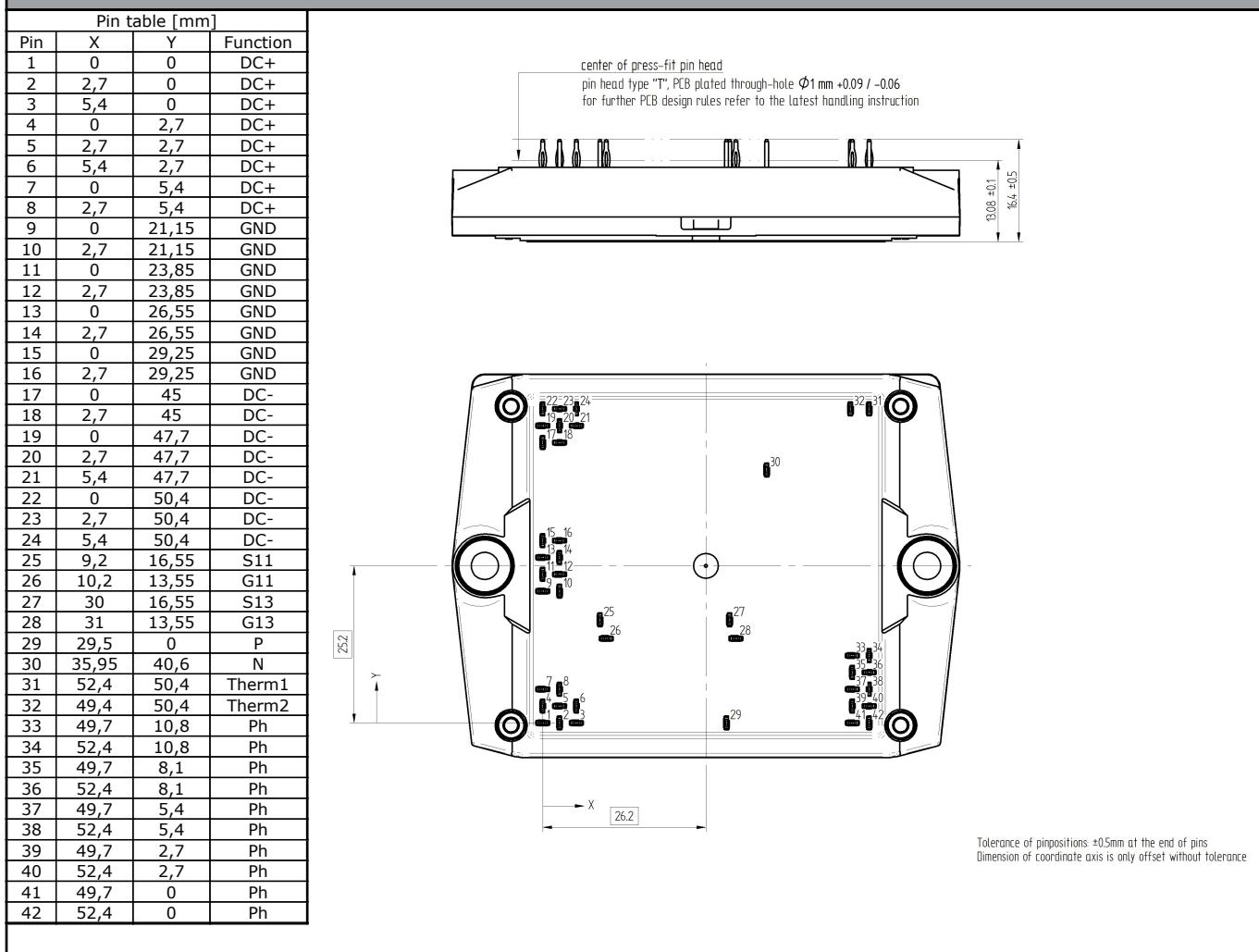
Version	Ordering Code
With thermal paste	B0-SP07NIB300S5-LT82F58T-7/

Marking

Text	Name	Date code	Logo	Lot	Serial
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Datamatrix	Type&Ver TTTTTVV	Lot number LLLLL	Serial SSSS	Date code WWYY	

High Side Module B0-SP07NIB300S5-LT82F58T

Outline



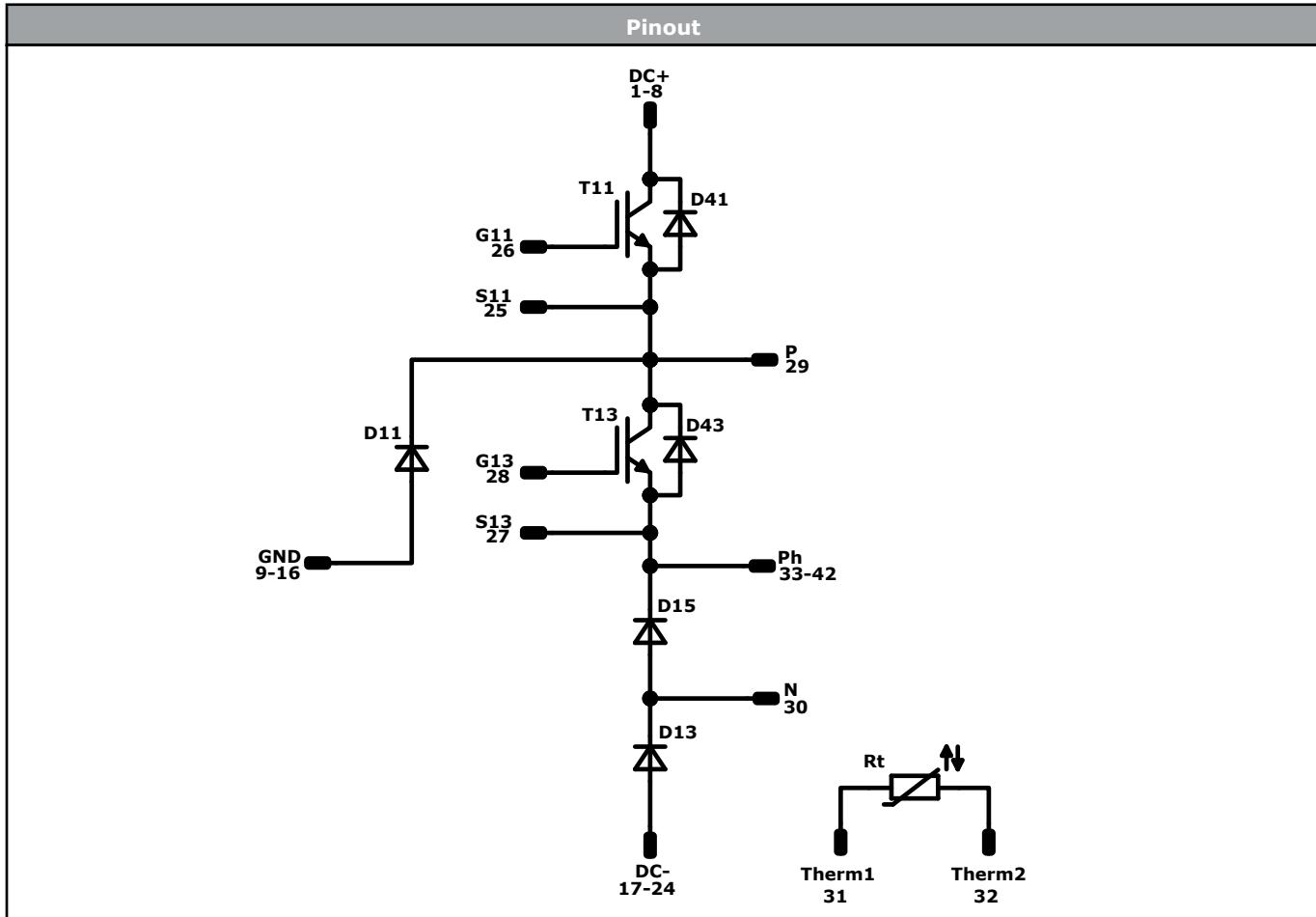


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B0-SP07NIC300S5-LT92F58T**

datasheet

High Side Module B0-SP07NIB300S5-LT82F58T



Identification

ID	Component	Voltage	Current	Function	Comment
T11	IGBT	650 V	300 A	Buck Switch	
D11	FWD	650 V	300 A	Buck Diode	
D41	FWD	650 V	30 A	Buck Sw. Protection Diode	
T13	IGBT	650 V	300 A	Boost Switch	
D13	FWD	650 V	300 A	Boost Diode	
D15	FWD	650 V	300 A	Boost Sw. Inv. Diode	
D43	FWD	650 V	30 A	Boost Sw. Protection Diode	
Rt	Thermistor			Thermistor	



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Ordering Code

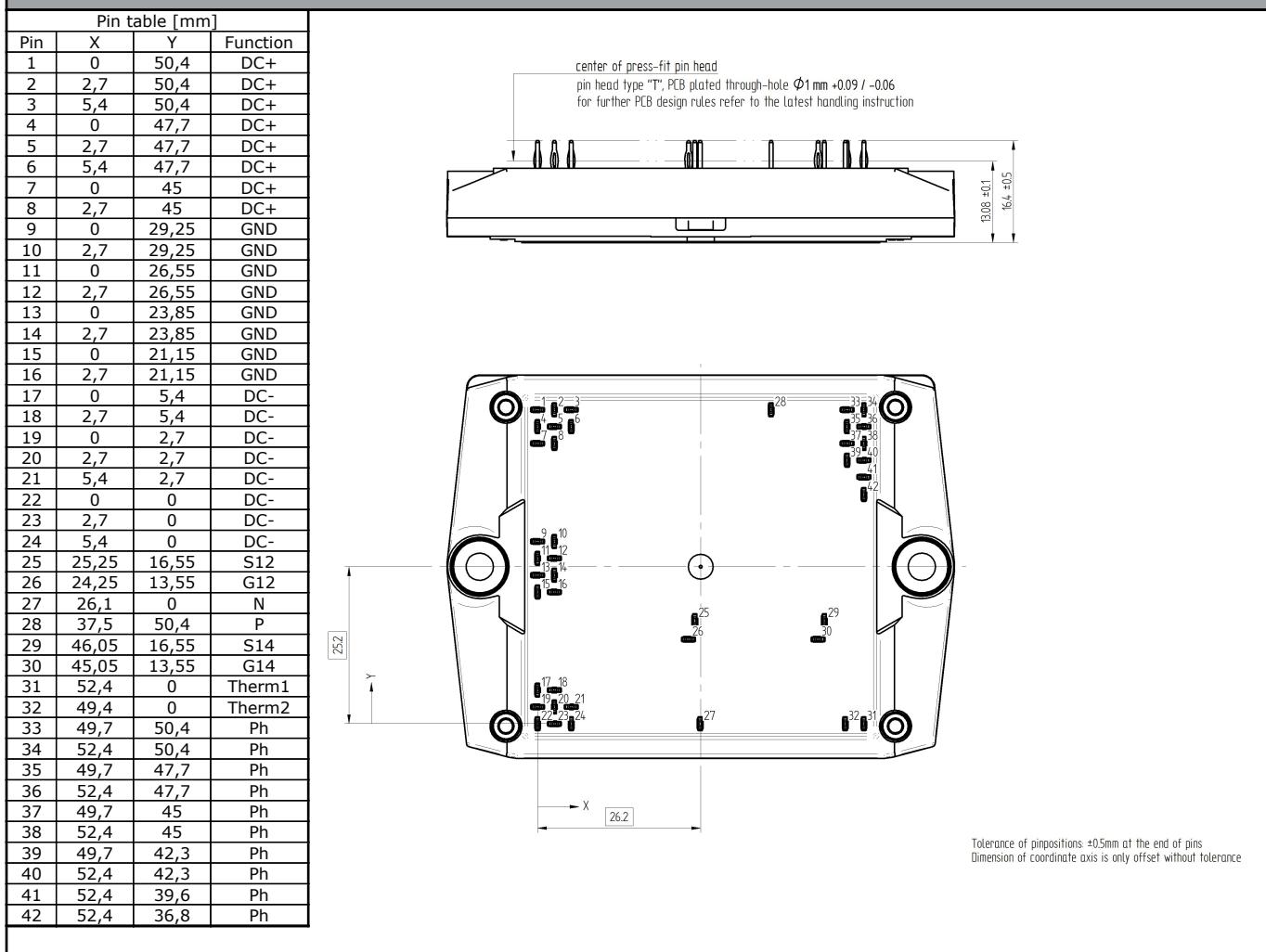
Version	Ordering Code
With thermal paste	B0-SP07NIC300S5-LT92F58T-7/

Marking

Text	Name	Date code	Logo	Lot	Serial
NN-NNNNNNNNNNNNN TTTTTVV WWWYY VIN LLLLL SSSSS	NN-NNNNNNNNNNNNNN- TTTTTVV	WWYY	VIN	LLLLL	SSSS
Datamatrix	Type&Ver	Lot number	Serial	Date code	
	TTTTTVV	LLLLL	SSSS	WWYY	

Low Side Module B0-SP07NIC300S5-LT92F58T

Outline



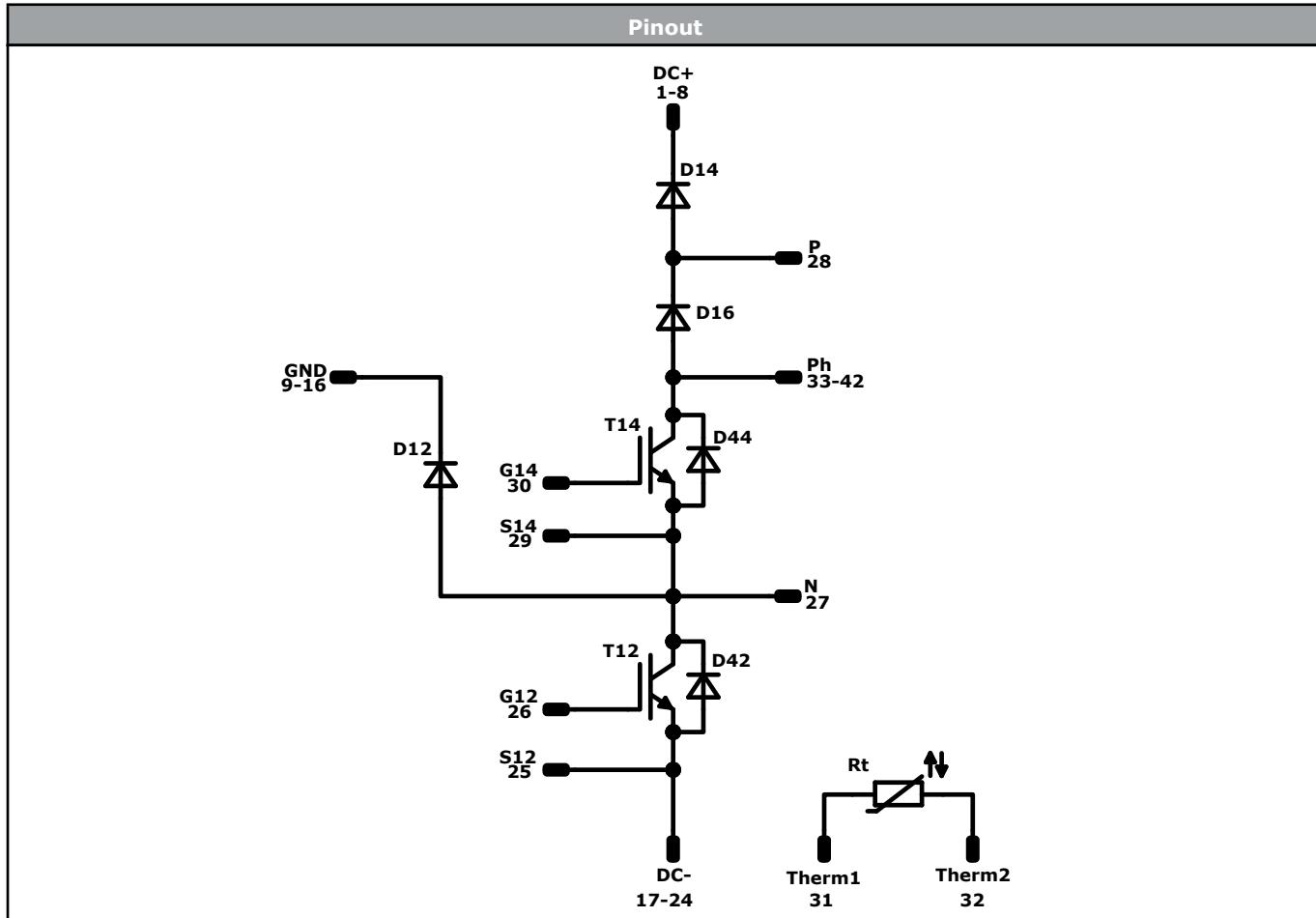


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B0-SP07NIC300S5-LT92F58T

datasheet

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Low Side Module B0-SP07NIC300S5-LT92F58T



Identification					
ID	Component	Voltage	Current	Function	Comment
T12	IGBT	650 V	300 A	Buck Switch	
D12	FWD	650 V	300 A	Buck Diode	
D42	FWD	650 V	30 A	Buck Sw. Protection Diode	
T14	IGBT	650 V	300 A	Boost Switch	
D14	FWD	650 V	300 A	Boost Diode	
D16	FWD	650 V	300 A	Boost Sw. Inv. Diode	
D44	FWD	650 V	30 A	Boost Sw. Protection Diode	
Rt	Thermistor			Thermistor	



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Packaging instruction

Standard packaging quantity (SPQ) 45	>SPQ	Standard	<SPQ	Sample
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Handling instruction

Handling instructions for flow S3 packages see vincotech.com website.

Package data

Package data for flow S3 packages see vincotech.com website.

Vincotech thermistor reference

See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number

Certification pending. For more information see vincotech.com website.

Document No.:	Date:	Modification:	Pages
B0-SP07NIx300S5-LTx2F58T-D1-14	7 Oct. 2020		

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.